LP4131

Sensorless 2-Cell 1A Boost Switching Charger

Features

- Easy-to-use standalone 2-cell switching charger
  - Proprietary sensorless charge current control
  - 4.5V to 6.2V input voltage operation
  - 20V absolute maximum input voltage rating
  - Charge voltages 8.4V/8.6V/8.7V
  - 0.35 -1A programmable fast charge current
  - 600kHz switching frequency
  - 90% charge efficiency at 1A charge
  - Support Precharge, Constant Current (CC) charge, Constant Voltage (CV) charge, charge termination and recharge
- Charge accuracy
  - +/- 0.75% charge voltage regulation
  - +/- 10% charge current regulation
  - 150mA precharge current
  - 150mA termination current
- Protections
  - Cycle-by-cycle current limit protection
  - Input voltage regulation (VINDPM)
  - Junction temperature thermal regulation(TREG)
  - Over junction temperature protection
- Packaging
  - SOT23-6L
  - RoHS compliant and halogen free
  - 100% lead (Pb) free

Applications

- BT speaker
- Portable printers
- Toys
- 2-cell battery pack
- Power tools

General Description

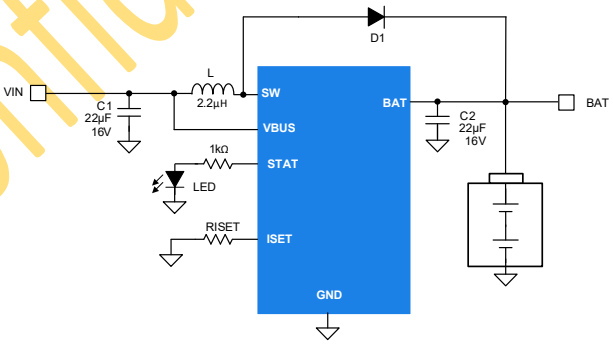
The LP4131 is a cost-effective standalone Boost 2-cell battery charger. The switching frequency is 600kHz to allow a 2.2uH inductor. The fast charge current is programmable by a resistor at ISET pin from 0.35A to 1A. Charge status is indicated by STAT pin driving a LED. The LP4131 is recommended to be supplied from a voltage source with output current limit function. The LP4131 offers SOT23-6L package.

Order Information

LP4131 □□ □

F: Pb-Free
Package Type
B6: SOT23-6L

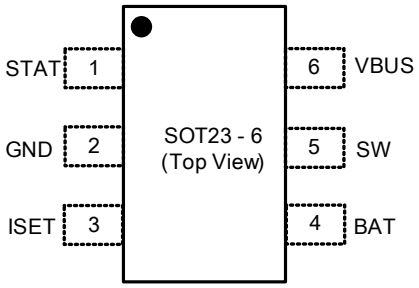
Application Circuit



Device Information

Part Number	Charge Voltage	Top Marking	Package	Moisture Sensitivity Level	Shipping
LP4131B6F	8.4V	LGYWX	SOT23-6L	MLS3	3K/REEL
LP4131B6F-430	8.6V	TBD	SOT23-6L	MLS3	3K/REEL
LP4131B6F-435	8.7V	TBD	SOT23-6L	MLS3	3K/REEL
Marking indication: Y: Year code. W: Week code. X: Batch numbers.					

Pin Diagram



SOT23-6L

(Top View)

Pin Description

Pin Name	Pin Number	Description
STAT	1	Charge status indication output. Connect a LED from STAT pin to GND via a current limiting resistor. The STAT pin indicates charge status: Charge in progress: STAT pin is pulled high to an internal supply Charge complete or not in charge: STAT pin is internally open.
GND	2	Ground
ISET	3	Charge current program input. Connect a 1% resistor RISET from this pin to ground to program the charge current. If ISET pin is floating, charge current is minimized. If ISET pin is pulled below 0.5V, charge is disabled.
BAT	4	Battery voltage sense input
SW	5	Switching node. Connect to a terminal of inductor.
VBUS	6	Device input voltage

Absolute Maximum Ratings (Note)

VBUS Voltage to GND ---------- -0.3V to 20V
SW and BAT Voltage to GND ---------- -0.3V to 30V
STAT, ISET, Voltages to GND ---------- -0.3V to 6V
STAT Source Current ---------- 6mA
Maximum Junction Temperature (Tj) ---------- 150℃
Storage Temperature Range ---------- -40℃ to 150℃
Maximum Soldering Temperature (at leads, 10 sec) ---------- 260℃

Note: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD Ratings

HBM (Human Body Model) ---------- 2kV
MM (Machine Model) ---------- 200V
CDM (Charge Discharge Model) ---------- 500V

Thermal Information

θ_{JA} (Junction-to-Ambient Thermal Resistance) for SOT23 - 6L ---------- 100℃/W

Recommended Operating Conditions

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
V_{IN}	Input Voltage	4.5		6.2	V
I_{CHG}	Fast Charge Current	0.35		1	A
V_{BATREG}	Battery Charge Voltage	8.4		8.7	V
T_J	Operating Junction Temperature Range (T_J)	-40		125	℃
T_A	Ambient Temperature Range	-40		85	℃

Recommended Component Parameter Range (1)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
C_{VBUS}	Input Capacitance at VBUS	6	22		μF
C_{BAT}	BAT Capacitance(1)	6	22		μF
L1	Boost Inductance (1)	1.76	2.2	4.7	μH

Notes:

(1) The values recommended in the table are effective inductance and capacitance.

Electrical Characteristics

(The specifications are at V_{VBUS}=5V, V_{BAT}=7.4V, T_J = 25°C unless otherwise noted)

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
QUIESCENT CURRENT						
I_{Q_BAT}	Battery reverse current	No VBUS VBAT = 8.4V			5	μA
I_{Q_BAT}	Battery leak current at termination	Charge is terminated, V_{BAT} = 8.4V			15	μA
INPUT VOLTAGE AND CURRENT						
V_{UVLO_RISE}	Under voltage lock out(UVLO) voltage	V_{VBUS} rising		3.8		V
V_{UVLO_FALL}	UVLO voltage	V_{VBUS} falling		300		mV
V_{OP_MIN}	Min operation input voltage	V_{VBUS} rising			4.5	V
V_{INDPM}	VINDPM at VBUS	Regulated at VBUS pin		4.35		V
V_{VBUS_OVP}	VBUS over voltage protection	V_{VBUS} rising		6.4		V
V_{VBUS_OVP}	VBUS over voltage protection hysteresis	V_{VBUS} falling		300		mV
BOOST CONVERTER						
R_{DSON_Q1}	Boost NFET on-resistance	V_{VBUS}=5V		90		mΩ
f_{SW}	Switching frequency			600		kHz
I_{OCP1}	Over current limit			5.5		A
D_{MAX}	Maximum duty cycle			92		%
V_{SCP_FALL}	Boost short circuit detection	V_{SCP} = (V_{VBUS} - V_{BAT}) V_{BAT} falling, Boost disabled	0.65	0.80	0.95	V
V_{SCP_RISE}	Boost short circuit detection	V_{SCP} = (V_{VBUS} - V_{BAT}) V_{BAT} rising, Boost startup	0.35	0.50	0.65	V

Electrical Characteristics

(The specifications are at V_{VBUS} =5V, V_{BAT}=7.4V, T_J = 25°C unless otherwise noted)

ISET CHARGE CURRENT SETTING						
V_{ISET}	ISET pin voltage		0.985	1	1.015	V
I_{CHG}	Charge current setting range		0.3		1	A
K_{ICHG}	Charge current ratio			40		AxkΩ
V_{ISET_SHORT}	ISET pin short protection threshold			0.5		V
STAT INDICATION						
V_{STAT}	STAT pull-up voltage	STAT internally pulled up to V_{STAT} V_{BUS} = 5V, I_{STAT}=0	4.5	5		V
V_{STAT}	STAT pull-up voltage	STAT internally pulled up to V_{STAT} V_{BUS} = 5V, I_{STAT} = 6mA	4.0	4.5		V
I_{SAT_SOURCE}	STAT source current capability		6			mA
BATTERY CHARGER						
V_{BATREG}	Charge voltage	LP4131B6F		8.4		V
		LP4131B6F-430		8.6		V
		LP4131B6F-435		8.7		V
$V_{BAT\_LOWV\_RISE}$ %	V_{BAT} fast charge rising threshold	Precharge to fast charge threshold, as percentage of V_{BATREG}, VBAT rising		68		%
$V_{BAT\_LOWV\_FALL}$ %	V_{BAT} fast charge falling threshold	Fast charge to precharge charge threshold, as percentage of V_{BATREG}, VBAT falling		66		%
$V_{RECHG\_RISE\%}$	Recharge threshold	As percentage of V_{BATREG}, V_{BAT} rising		98		%
$V_{RECHG\_FALL\%}$	Recharge threshold	As percentage of V_{BATREG}, V_{BAT} falling		97.6		%
I_{CHG_CC}	Fast charge current	I_{CHG}=1A, V_{BAT}=7.4V		1000		mA
I_{CHG_CC}	Fast charge current	I_{CHG}=0.5A, V_{BAT}=7.4V		500		mA
I_{PRECHG}	Precharge current	V_{BAT} = 5V		150		mA
I_{TERM}	Termination current			150		mA

Electrical Characteristics

(The specifications are at V_{VBUS} =5V, V_{BAT}=3.7V per cell, T_J = 25°C unless otherwise noted)

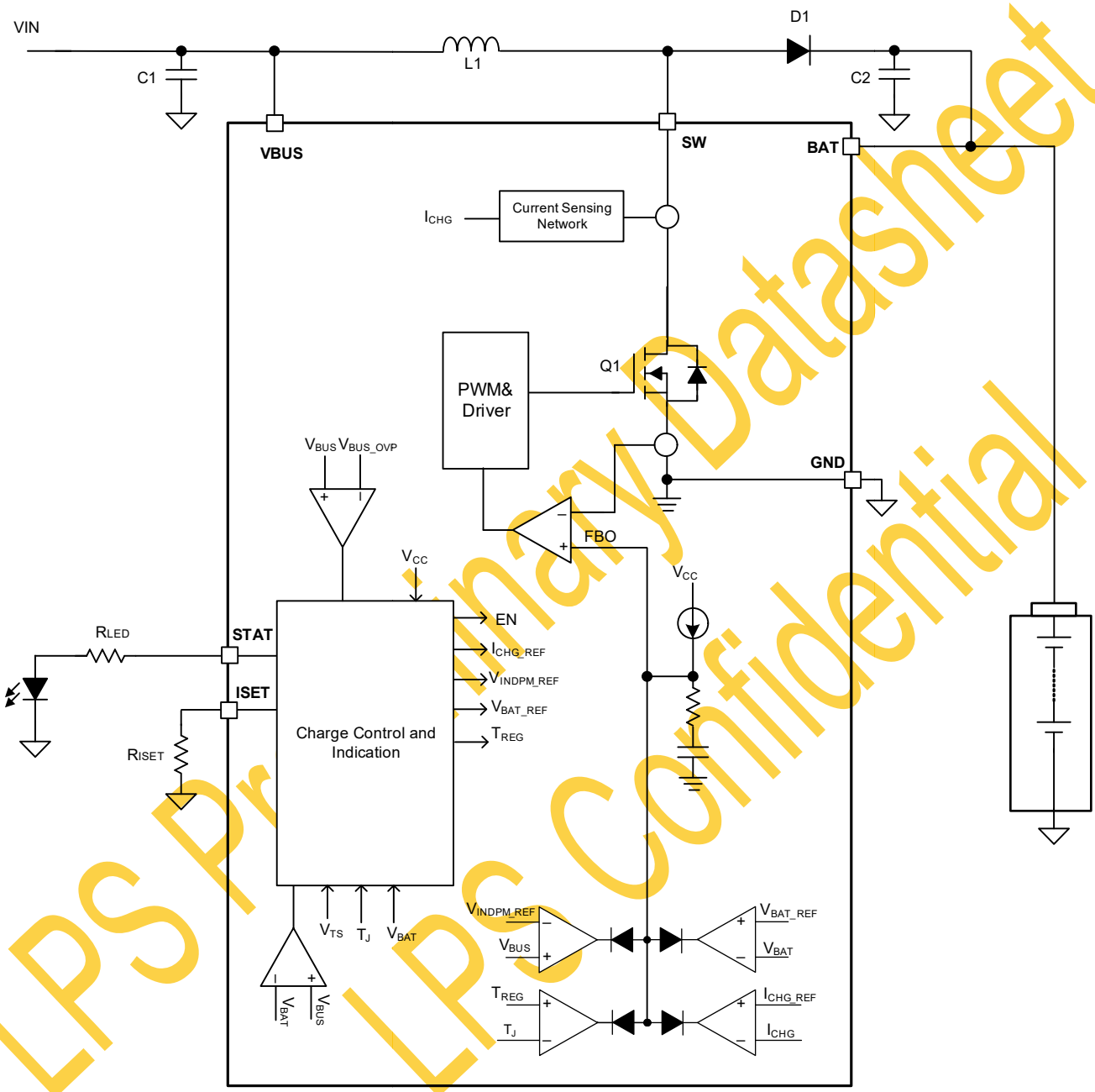
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
THERMAL REGULATION AND THERMAL SHUTDOWN						
T_{REG1}	Boost mode thermal regulation			118		°C
T_{SHUT_RISE}	Thermal shut down in all conditions	Temperature rising		150		°C
T_{SHUT_HYST}	Thermal shut down in all conditions	Temperature falling		30		°C
TIMING REQUIREMENTS						
t_{DELAY}	Input debounce time	Time delay from V_{UVLO_RISE} to Boost startup		20		ms
t_{SOFT}	Boost soft-start time			5.0		ms
$t_{BATLOWV}$	Precharge and fast charge detection deglitch time			200		us
t_{TERM}	Termination deglitch time			200		ms
t_{RECHG}	Recharge deglitch time			3.0		ms
t_{TS}	TS deglitch time			10		ms
t_{VBUS_OVP}	Input OVP detection time	From V_{VBUS} reaches OVP threshold to Boost switching stop			600	ns
t_{SCP1}	Out of Boost mode delay time	(V_{VBUS} - V_{BAT}) > V_{SCP_RISE}			200	ns
t_{SCP2}	Into Boost mode deglitch time	(V_{VBUS} - V_{BAT}) < V_{SCP_FALL}		1		ms

Typical Characteristics

(The schematic is as shown in Figure xx)

TBD

Functional Block Diagram



Boost Battery Charger

Detailed Description

Overview

The LP4131 is a cost-effective standalone 2-cell Boost switching battery charger that steps 4.5V-6.2V input voltage up to charge 2-cell batteries. The fast charge current is programmable by a resistor at ISET pin from 0.35A to 1A. The switching frequency is 600kHz to allow a 2.2uH inductor being used. Charge status is indicated by STAT pin driving a LED in series with a current limit resistor.

Charger Power-up

With VBUS voltage rise above V_{UVLO_RISE}, following a delay time of t_{DELAY}, if the voltage difference between V_{VBUS} and V_{BAT} is (V_{VBUS} - V_{BAT}) below V_{SCP_FALL} and VBUS is higher than UVLO threshold, Boost converter starts with charge current ramping up.

Device Functional Mode

The device operates in different modes depending on V_{VBUS}, V_{BAT} and ISET pin connection. The functional modes are listed in the following table.

Table 1: Device Functional Mode

MODE	CONDITIONS	CHARGE	STAT
HiZ Mode	$V_{VBUS} < V_{UVLO}$	NO	OPEN
Boost Disabled	$(V_{VBUS} - V_{BAT}) > V_{SCP\_RISE}$	NO	OPEN
VINDPM Mode	$V_{VBUS} = V_{INDPM}$	YES	HIGH
Boost Mode	$(V_{VBUS} - V_{BAT}) < V_{SCP\_FALL}$ and $V_{VBUS} > V_{UVLO}$	YES	HIGH
Precharge Mode	$(V_{VBUS} - V_{SCP\_FALL}) < V_{BAT} < V_{BAT\_LOWV}$	YES	HIGH
Fast Charge Mode	$V_{BAT} > V_{BAT\_LOWV}$	YES	HIGH
Charge Termination	$I_{CHG} < I_{TERM}$ $V_{BAT} > V_{RECHG\_RISE\%}$ of V_{BAT}	NO	OPEN
Fault Mode	$T_J > T_{SHUT}$ or Input OVP	NO	OPEN
ISET Short	ISET pin short to GND	No	OPEN

Boost Converter

The Boost converter is allowed to operate if $V_{VBUS} > V_{UVLO}$ and $V_{VBUS} < V_{SCP\_FALL} + V_{BAT}$ and faults is not detected. The Boost converter is under control of input voltage, constant current, thermal regulation, battery voltage regulation loops and only one of the loops controls Boost duty cycle at one time. If the battery voltage falls below (V_{VBUS} - V_{SCP_RISE}), the Boost converter stops switching and allow VBUS to limit potential short circuit current.

Battery Charge Profile

As shown in Figure 1, the battery charge current is determined by precharge current and constant charge current as well as battery voltage.

Precharge

The device charges the battery at 150mA in precharge mode if a battery voltage is below 66% of V_{BATREG}.

Constant Current (CC) Charge

CC charge is also called fast charge. The device charges the battery from Boost converter at current level of K_{ICHG} / R_{ISET}, where K_{ICHG} is the gain of charge current setting and R_{ISET} is the resistance value from ISET to GND.

Constant Voltage (CV) Charge

With the battery voltage charged up, the BAT pin voltage reaches the battery regulation voltage V_{BATREG} and the charge current starts to decrease from fast charge current I_{CHG_CC}. The actual battery voltage keeps increasing and charge current decreasing until charge termination conditions are met and charge is terminated.

Charge Termination

The device terminates a charge cycle when the battery voltage is above recharge threshold V_{BATREG}*$V_{RECHG\_RISE\%}$ and the charge current is below termination current I_{TERM} for deglitch time t_{TERM}. The termination current threshold I_{TERM} is fixed at 150mA.

Battery Recharge

Once a charge cycle is terminated, if battery voltage V_{BAT} decreases below the recharge threshold V_{BATREG}*$V_{RECHG\_FALL\%}$ and the charge conditions are met, the charger is enabled again. In addition to recharge, charge cycle starts if V_{VBUS} voltage is recycled. Each time when battery is recharged, a Boost soft-start is inserted.

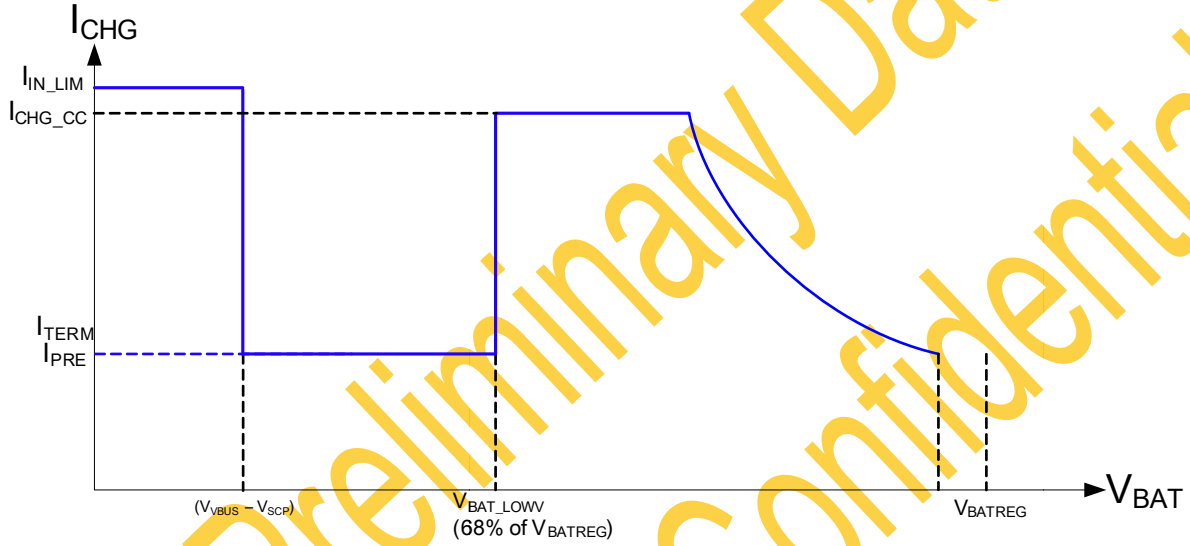


Figure 1. Battery Charge Current vs. Battery Voltage

Battery Short

If short circuit occur at BAT pin, the short circuit current is bypassed from input supply through inductor and schottky diode. The device does not limit the short circuit current. Instead, when short circuit is detected, the Boost converter turns off and waits until V_{BAT} rises to a threshold. Battery pack itself provides short circuit protection if a battery packs is shorted to GND externally. The AC or DC adaptors usually build short circuit protection with constant output current limit or over current protection (OCP), which prevents battery over charge.

ISET Pin Short

If ISET pin is open, the charge current is minimized. If ISET pin is shorted to GND, internal charge current is clamped and (V_{ISET}<0.5V), the charge is disabled and STAT pin is open. ISET pin can be used as enable input for charge enable or disable. An open-drain GPIO in parallel with R_{ISET} can be connected to ISET pin to enable and disable charge. When ISET pin is released from short, the charger goes through soft-start process.

Input Voltage Dynamic Power Management (VINDPM)

When the input current of the device exceeds the current capability of the power supply, the charger device regulates VBUS voltage by reducing charge current to avoid crashing the input power supply. To charge a battery, the input voltage must be higher than actual V_{INDPM} threshold. In VINDPM regulation, termination is temporarily disabled. VINDPM is enabled once Boost converter is in operation.

Thermal Regulation (TREG)

The device monitors the junction temperature T_J to avoid overheating the chip and limit the device surface temperature. When the internal junction temperature exceeds thermal regulation limit T_{REG}, the Boost lowers down the charge current. During thermal regulation, the average charging current is below the programmed battery charging current. In thermal regulation, termination is temporarily disabled.

Thermal Shutdown (TSHUT)

The devices have thermal shutdown built in to turn off the charger when device junction temperature exceeds T_{SHUT}. The charger is re-enabled with soft-start when the junction temperature is 30°C below T_{SHUT}. During thermal shutdown, charge is suspended.

Application and Implementation

Application Information

The device can be used for general purpose 2-cell battery charger with minimal number of external components. The charge current is programmable by a resistor from ISET pin to GND.

Application Schematic

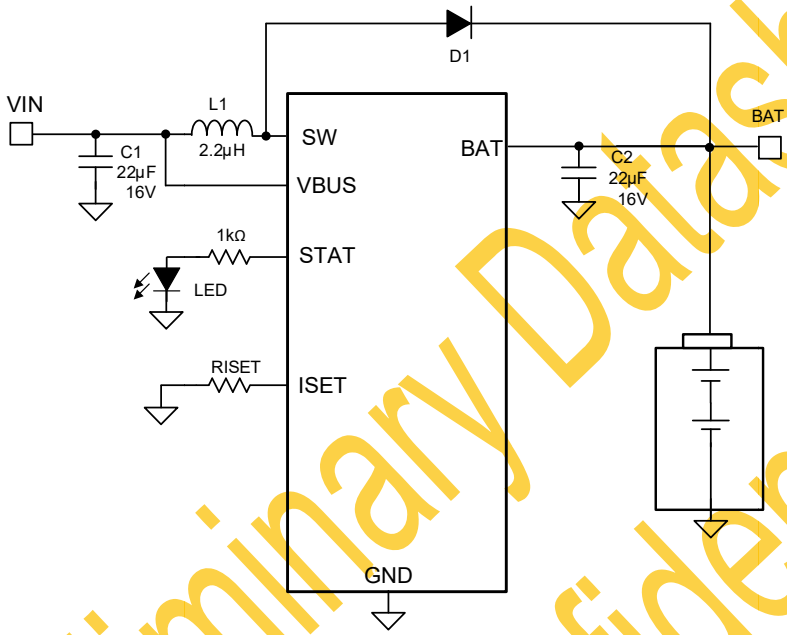


Figure 3: Typical Applications Schematic

Charge Current Setting

The charger current is set by the resistor value at the ISET pin according to the equation below:

$$I_{CHG}\,(A) = K_{ICHG}\,(A{\cdot}k\Omega) / R_{ISET}(k\Omega) \qquad (3)$$

K_{ICHG} is current setting gain that is listed in Electrical Characteristics table and RISET is the resistor value from ISET pin to GND. K_{ICHG} is typically 40 (A·kΩ) and the typical values vs. charge currents are illustrated in Figure xx in Typical Characteristics.

Application and Implementation (TBD)

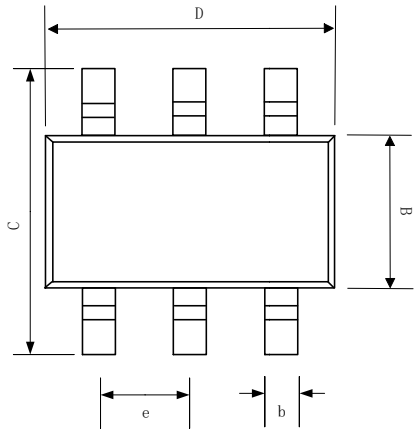
Application Curves

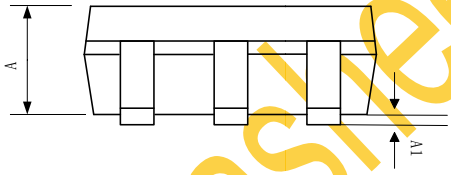
PCB Layout Guideline (TBD)

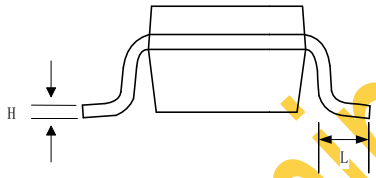
Appropriate PCB layout is important in the power supply design. Good PCB layout minimizes EMI and noises, allows good output voltage regulation and achieves higher efficiency. The following design considerations are recommended:

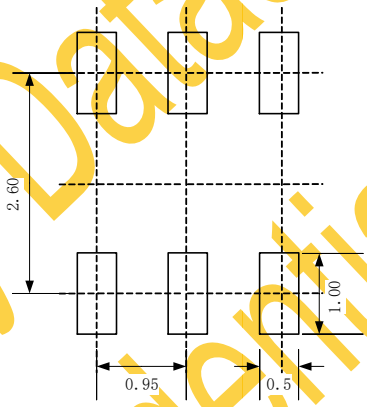
- Decouple BAT and VBUS pins to GND on top layer and place decoupling capacitors as close to those pins as possible. Always avoid vias if possible because they have parasitic inductance and resistance. If vias are inevitable, always use more than one vias in parallel to decrease parasitics for power traces.
- Connect GND pad to the ground plane on the bottom side with multiple vias that is for both heat dissipation and electrical connection.
- Minimize switching SW node size and trace lengths and keep it away from ISET and BAT traces.

Package Information







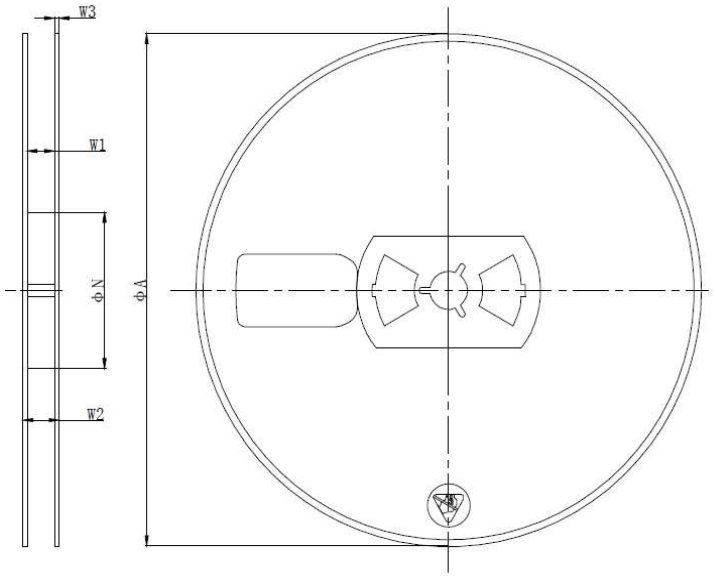


Recommended Land Pattern

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.889	1.100	1.295
A1	0.000	0.050	0.152
B	1.397	1.600	1.803
b	0.28	0.35	0.559
C	2.591	2.800	3.000
D	2.692	2.920	3.120
e	0.95BSC		
H	0.080	0.152	0.254
L	0.300	0.450	0.610

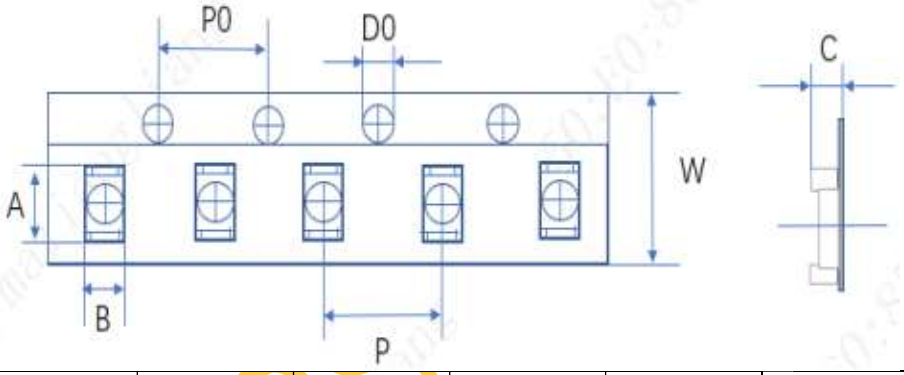
Carrier Information

Reel Dimensions (Unit: mm)



Device	ΦA	W2
LP4131B6F	180±4	12±3

Tape Dimension (Unit: mm)



Device	A	B	P0	P	D0	W	C
LP4131B6F	3.20±0.30	3.26±0.30	4.00±0.20	4.00±0.20	1.50±0.20	8.00±0.30	1.40±0.20

SOT23-6L